# IGBT - Field Stop II / 4 Lead

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Field Stop II Trench construction, and provides superior performance in demanding switching applications, offering both low on state voltage and minimal switching loss. In addition, this new device is packaged in a TO-247-4L package that provides significant reduction in Eon Losses compared to standard TO-247-3L package. The IGBT is well suited for UPS and solar applications. Incorporated into the device is a soft and fast co-packaged free wheeling diode with a low forward voltage.

#### Features

- Extremely Efficient Trench with Field Stop Technology
- $T_{Jmax} = 175^{\circ}C$
- Improved Gate Control Lowers Switching Losses
- Separate Emitter Drive Pin
- TO-247-4L for Minimal Eon Losses
- Optimized for High Speed Switching
- This is a Pb–Free Devices

#### **Typical Applications**

- Solar Inverters
- Uninterruptible Power Supplies (UPS)
- Neutral Point Clamp Topology

#### **ABSOLUTE MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Collector-emitter voltage	V <sub>CES</sub>	1200	V
Collector current @ Tc = 25°C @ Tc = 100°C	Ι <sub>C</sub>	100 25	A
Pulsed collector current, $T_{pulse}$ limited by $T_{Jmax}$	I <sub>CM</sub>	100	A
Diode forward current @ Tc = 25°C @ Tc = 100°C	١ <sub>F</sub>	100 25	A
Diode pulsed current, $T_{pulse}$ limited by $T_{Jmax}$	I <sub>FM</sub>	100	A
Gate-emitter voltage Transient gate-emitter voltage $(T_{pulse} = 5 \ \mu s, D < 0.10)$	V <sub>GE</sub>	±20 ±30	V
Power Dissipation @ Tc = 25°C @ Tc = 100°C	PD	385 192	W
Operating junction temperature range	Τ <sub>J</sub>	-55 to +175	°C
Storage temperature range	T <sub>stg</sub>	-55 to +175	°C
Lead temperature for soldering, 1/8" from case for 5 seconds	T <sub>SLD</sub>	260	°C

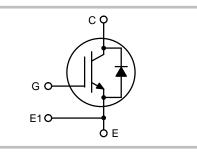
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

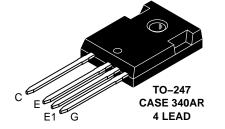


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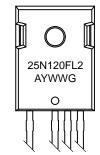
www.onsemi.com

25 A, 1200 V V<sub>CEsat</sub> = 2.0 V  $E_{on} = 0.99 \text{ mJ}$ 





MARKING DIAGRAM



25N120FL2 = Specific Device Code

- А = Assembly Location Υ
  - = Year
- WW = Work Week G
  - = Pb-Free Package

#### **ORDERING INFORMATION**

Device	Package	Shipping
NGTB25N120FL2WAG	TO–247 (Pb–Free)	30 Units / Rail

#### THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Thermal resistance junction-to-case, for IGBT		0.39	°C/W
Thermal resistance junction-to-case, for Diode		0.64	°C/W
Thermal resistance junction-to-ambient		25	°C/W

#### **ELECTRICAL CHARACTERISTICS** ( $T_J = 25^{\circ}C$ unless otherwise specified)

Parameter	Test Conditions	Symbol	Min	Тур	Мах	Unit
STATIC CHARACTERISTIC						
Collector-emitter breakdown voltage, gate-emitter short-circuited	$V_{GE} = 0 \text{ V}, \text{ I}_{C} = 500 \mu\text{A}$	V <sub>(BR)CES</sub>	1200	-	_	V
Collector-emitter saturation voltage	$V_{GE}$ = 15 V, I <sub>C</sub> = 25 A $V_{GE}$ = 15 V, I <sub>C</sub> = 25 A, T <sub>J</sub> = 175°C	V <sub>CEsat</sub>	-	2.00 2.40	2.40 -	V
Gate-emitter threshold voltage	$V_{GE} = V_{CE}$ , $I_C = 400 \ \mu A$	V <sub>GE(th)</sub>	4.5	5.5	6.5	V
Collector-emitter cut-off current, gate- emitter short-circuited	$V_{GE} = 0 V$ , $V_{CE} = 1200 V$ $V_{GE} = 0 V$ , $V_{CE} = 1200 V$ , $T_{J} = 175^{\circ}C$	I <sub>CES</sub>		_ 4.0	0.4 -	mA
Gate leakage current, collector-emitter short-circuited	$V_{GE} = 20 \text{ V}$ , $V_{CE} = 0 \text{ V}$	I <sub>GES</sub>	I	-	200	nA

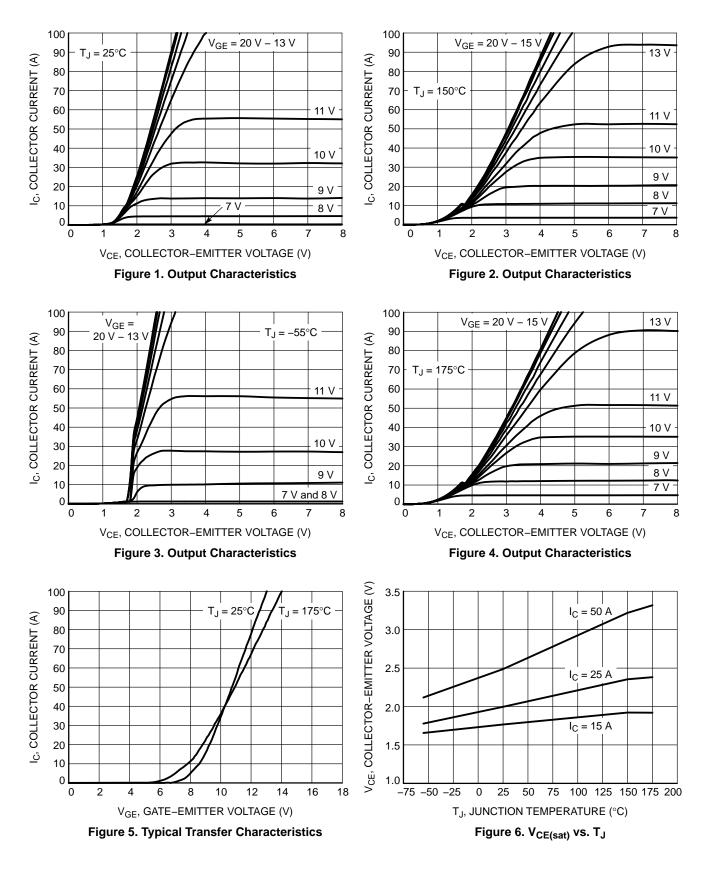
Input capacitance		Cies	-	4243	-	pF
Output capacitance	V <sub>CE</sub> = 20 V, V <sub>GE</sub> = 0 V, f = 1 MHz	C <sub>oes</sub>	-	159	-	
Reverse transfer capacitance		Cres	-	77	-	
Gate charge total		Qg	-	181	-	nC
Gate to emitter charge	$V_{CE} = 600 \text{ V}, I_C = 25 \text{ A}, V_{GE} = 15 \text{ V}$	Q <sub>ge</sub>	-	40	-	
Gate to collector charge		Q <sub>ac</sub>	-	87	_	1

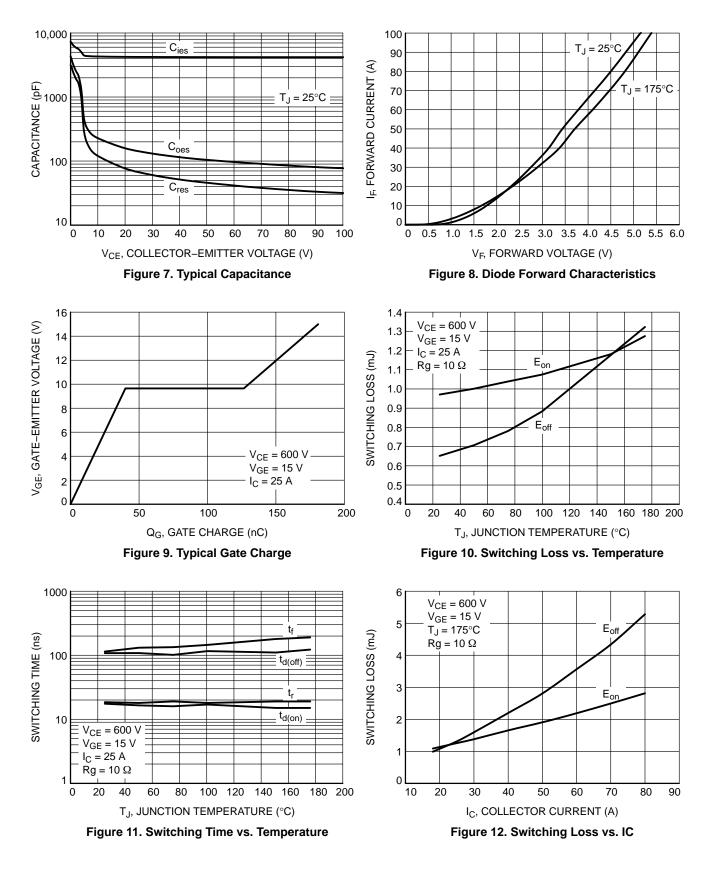
#### SWITCHING CHARACTERISTIC, INDUCTIVE LOAD

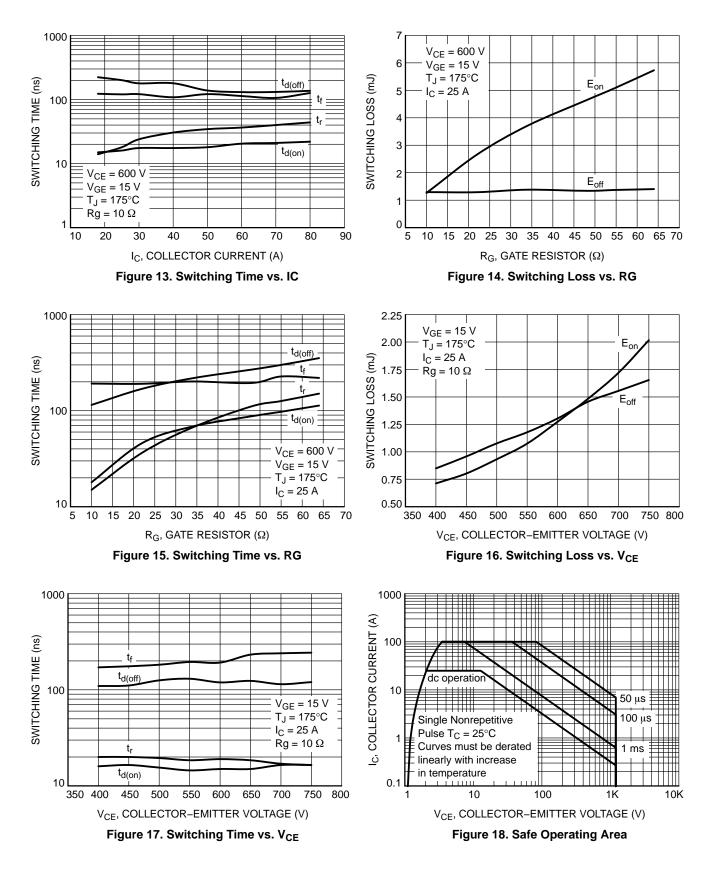
Turn-on delay time		t <sub>d(on)</sub>	-	17	-	ns
Rise time		t <sub>r</sub>	-	19	_	
Turn-off delay time	T <sub>J</sub> = 25°C	t <sub>d(off)</sub>	-	113	-	
Fall time	$V_{CC} = 600 \text{ V}, \text{ I}_{C} = 50 \text{ A}$	t <sub>f</sub>	-	118	-	
Turn-on switching loss	$\begin{array}{c} T_{J} = 25^{\circ}C \\ V_{CC} = 600 \text{ V, } I_{C} = 50 \text{ A} \\ R_{g} = 10 \Omega \\ V_{GE} = \pm 15 \text{ V} \end{array}$	Eon	-	0.99	-	mJ
Turn-off switching loss		E <sub>off</sub>	-	0.66	-	
Total switching loss		E <sub>ts</sub>	-	1.65	-	
Turn-on delay time		t <sub>d(on)</sub>	-	15	-	ns
Rise time		t <sub>r</sub>	-	19	-	
Turn-off delay time	T <sub>J</sub> = 175°C	t <sub>d(off)</sub>	-	120	-	
Fall time	$T_{J} = 175 ^{\circ}C$ $V_{CC} = 600 \text{ V, } I_{C} = 50 \text{ A}$ $R_{g} = 10 \Omega$ $V_{GE} = \pm 15 \text{ V}$	t <sub>f</sub>	-	193	-	
Turn-on switching loss	$V_{GE} = \pm 15V$	Eon	-	1.2	-	mJ
Turn-off switching loss		E <sub>off</sub>	-	1.3	-	
Total switching loss		E <sub>ts</sub>	-	2.5	_	
DIODE CHARACTERISTIC						
Forward voltage	$V_{GE} = 0 \text{ V}, I_F = 25 \text{ A}$	V <sub>F</sub>	-	2.51	3.00	V

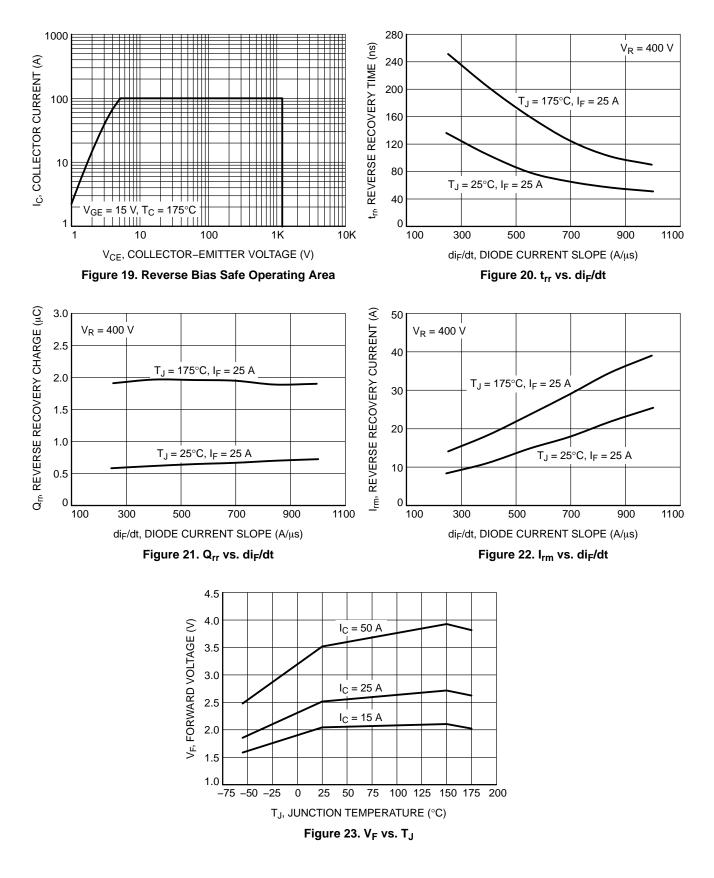
Forward voltage	V <sub>GE</sub> = 0 V, I <sub>F</sub> = 25 A V <sub>GE</sub> = 0 V, I <sub>F</sub> = 25 A, T <sub>J</sub> = 175°C	VF		2.51 2.60	3.00	V
Reverse recovery time	$T_J = 25^{\circ}C$	t <sub>rr</sub>	I	136	-	ns
Reverse recovery charge	I <sub>F</sub> = 25 Å, V <sub>R</sub> = 400 V di <sub>F</sub> /dt = 250 Å/μs	Q <sub>rr</sub>	I	0.6	-	μC
Reverse recovery current		I <sub>rrm</sub>	I	8.4	-	А
Reverse recovery time	$T_{J} = 175^{\circ}C$	t <sub>rr</sub>	I	251	-	ns
Reverse recovery charge	I <sub>F</sub> = 25 A, V <sub>R</sub> = 400 V di <sub>F</sub> /dt = 250 A/μs	Q <sub>rr</sub>	-	1.91	-	μC
Reverse recovery current		I <sub>rrm</sub>	_	14	_	Α

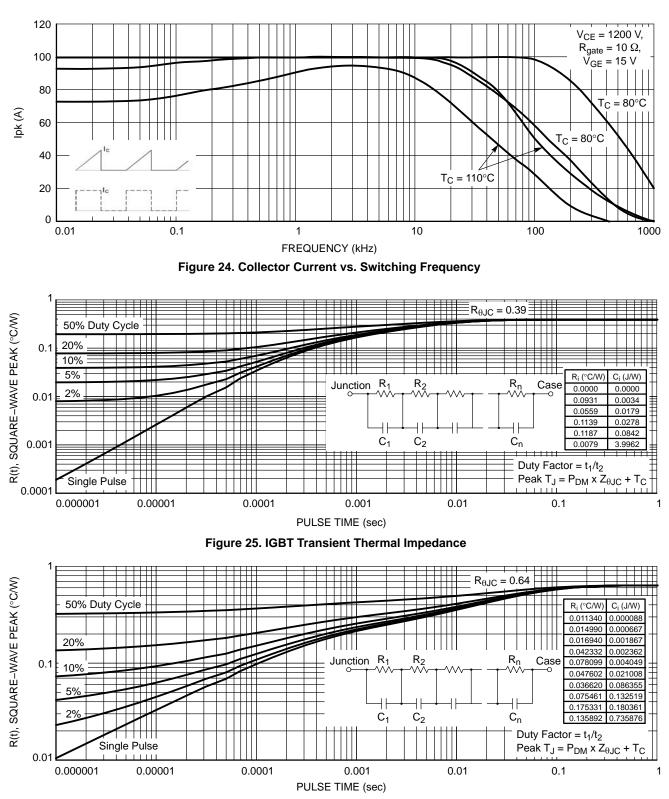
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.













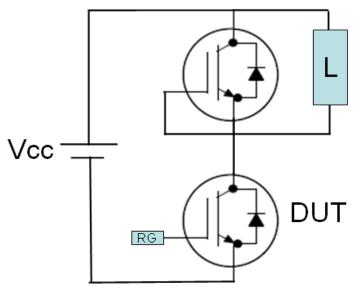


Figure 27. Test Circuit for Switching Characteristics

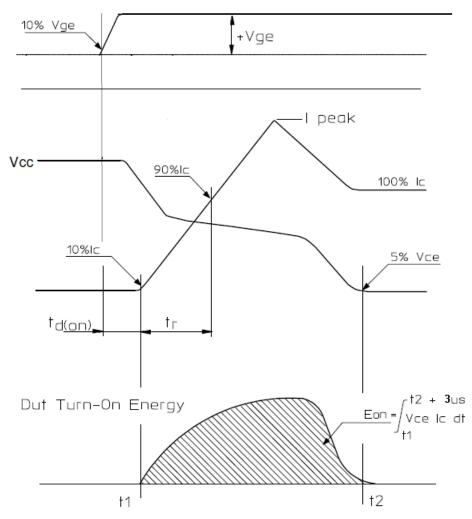


Figure 28. Definition of Turn On Waveform

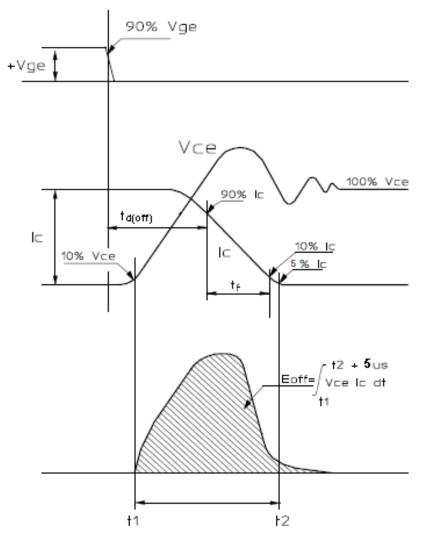
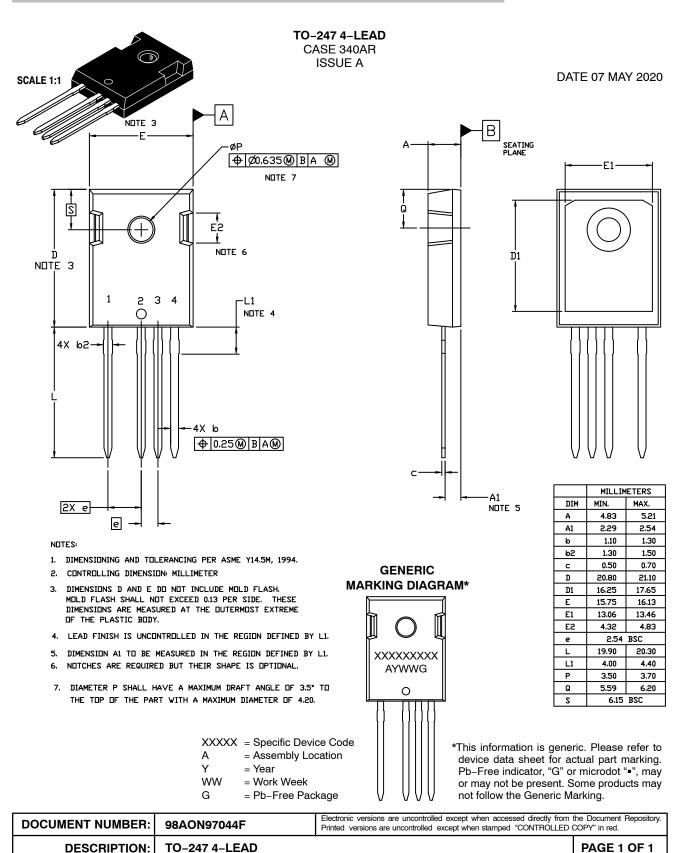


Figure 29. Definition of Turn Off Waveform

#### MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS





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